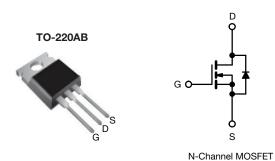
Vishay Siliconix

RoHS COMPLIANT

HALOGEN

FREE

E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 \text{ V}$	0.145		
Q _g (Max.) (nC)	86			
Q _{gs} (nC)	14			

25

Single

FEATURES

- Low figure-of-merit (FOM): Ron x Qg
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



- · Hard switched topologies
- Power factor correction power supplies (PFC)
- Switch mode power supplies (SMPS)
- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free and halogen-free	SiHP25N50E-BE3 ^a			
	SiHP25N50E-GE3			

Note

Q_{gd} (nC)

Configuration

a. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V_{DS}	500	V
Gate-source voltage			V_{GS}	± 30	v
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	- I _D	26	
		T _C = 100 °C		16	A
Pulsed drain current ^a			I _{DM}	50	
Linear derating factor				0.2	W/°C
Single pulse avalanche energy b			E _{AS}	273	mJ
Maximum power dissipation			P_{D}	250	W
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C		d\//d+	65	1//20
Reverse diode dV/dt ^d			dV/dt	25	V/ns
Soldering recommendations (peak temperature) c	For 10 s			300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.4 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W	
Maximum junction-to-case (drain)	R_{thJC}	-	0.5	G/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		•		Ţ	!	!	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	500	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.59	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$			4.0	V
Osta saura laslana	$V_{GS} = \pm 2$	$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zana anta nalta na dunia annuant		V _{DS} =	V _{DS} = 500 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 400 V	V _{DS} = 400 V, V _{GS} = 0 V, T _J = 125 °C		-	25	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 12 A	-	0.125	0.145	Ω
Forward transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 12 A		-	6.6	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1 MHz		-	1980	-	pF
Output capacitance	C _{oss}			-	105	-	
Reverse transfer capacitance	C _{rss}			-	8	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	105	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	285	-	
Total gate charge	Qg			-	57	86	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 12 \text{ A}, V_{DS} = 400 \text{ V}$	-	14	-	nC
Gate-drain charge	Q _{gd}			-	25	-	
Turn-on delay time	t _{d(on)}	$V_{DD} = 400 \text{ V}, I_{D} = 12 \text{ A}$ $R_{g} = 9.1 \Omega, V_{GS} = 10 \text{ V}$		-	19	38	ns
Rise time	t _r			-	36	72	
Turn-off delay time	t _{d(off)}			-	57	86	
Fall time	t _f			-	29	58	
Gate input resistance	R_g	f = 1 MHz, open drain		-	0.56	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET sym showing the	MOSFET symbol		-	12	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	50	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 16.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S,$ $dI/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$		-	338	-	ns
Reverse recovery charge	Q _{rr}			-	5.3	-	μC
Reverse recovery current	I _{RRM}			_	29	_	Α

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

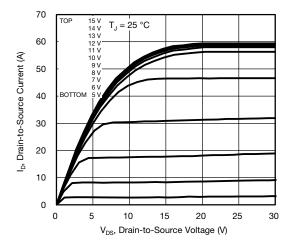


Fig. 1 - Typical Output Characteristics

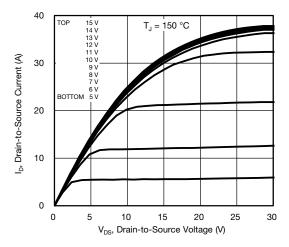


Fig. 2 - Typical Output Characteristics

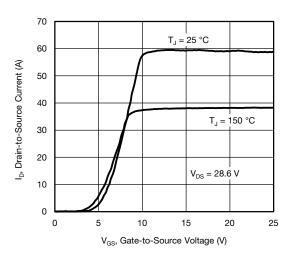


Fig. 3 - Typical Transfer Characteristics

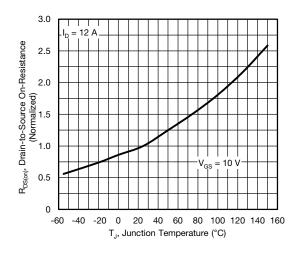


Fig. 4 - Normalized On-Resistance vs. Temperature

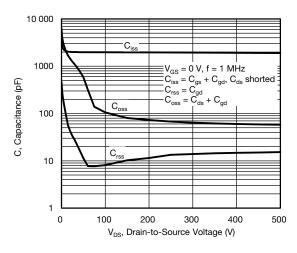


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

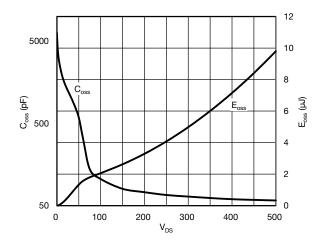


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}



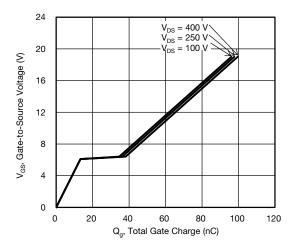


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

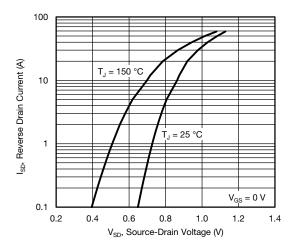


Fig. 8 - Typical Source-Drain Diode Forward Voltage

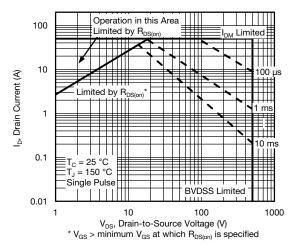


Fig. 9 - Maximum Safe Operating Area

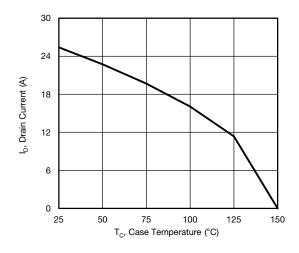


Fig. 10 - Maximum Drain Current vs. Case Temperature

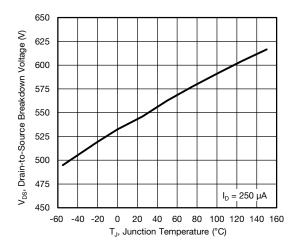


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature



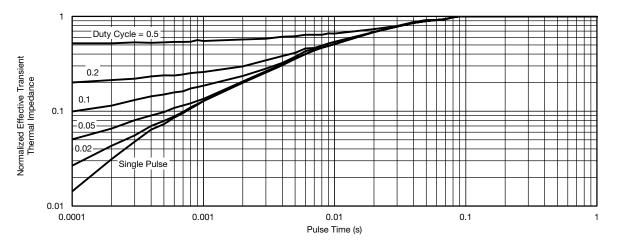


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

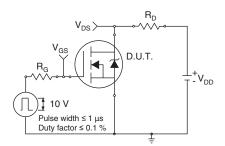


Fig. 13 - Switching Time Test Circuit

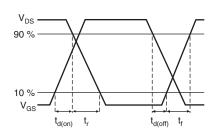


Fig. 14 - Switching Time Waveforms

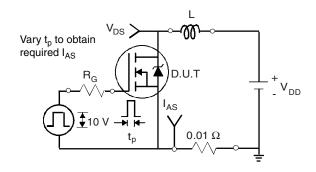


Fig. 15 - Unclamped Inductive Test Circuit

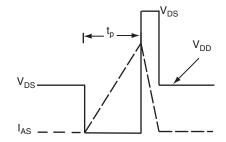


Fig. 16 - Unclamped Inductive Waveforms

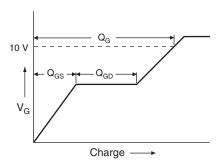


Fig. 17 - Basic Gate Charge Waveform

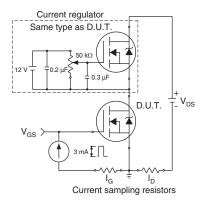
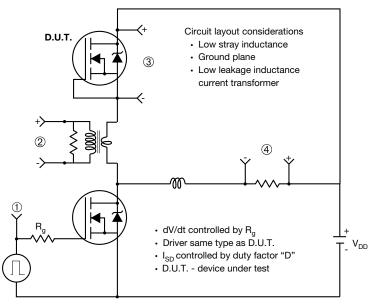


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



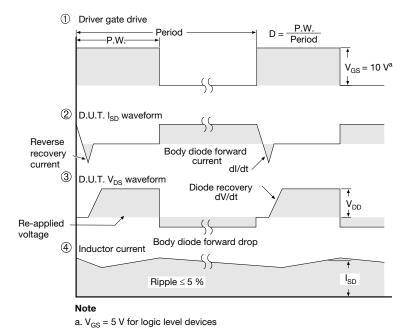


Fig. 19 - For N-Channel

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